

MATERIALS

HOUSING: HI-TEMP. PLASTIC (UL 94V-0)
 LATCH: SUS, TIN PLATING
 TERMINAL: COPPER ALLOY, GOLD PLATED ON CONTACT AREA
 TIN PLATING ON SOLDER TAIL

SPECIFICATION

CURRENT RATING: 0.5 AMP MAX
 DIELECTRIC WITHSTANDING: 250V AC FOR ONE MINUTE
 CONTACT RESISTANCE: 30m OHMS MAX
 INSULATION RESISTANCE: 500M OHMS MIN AT DC 500V
 OPERATION TEMPERATURE: -55°C~+85°C

PART NUMBER:

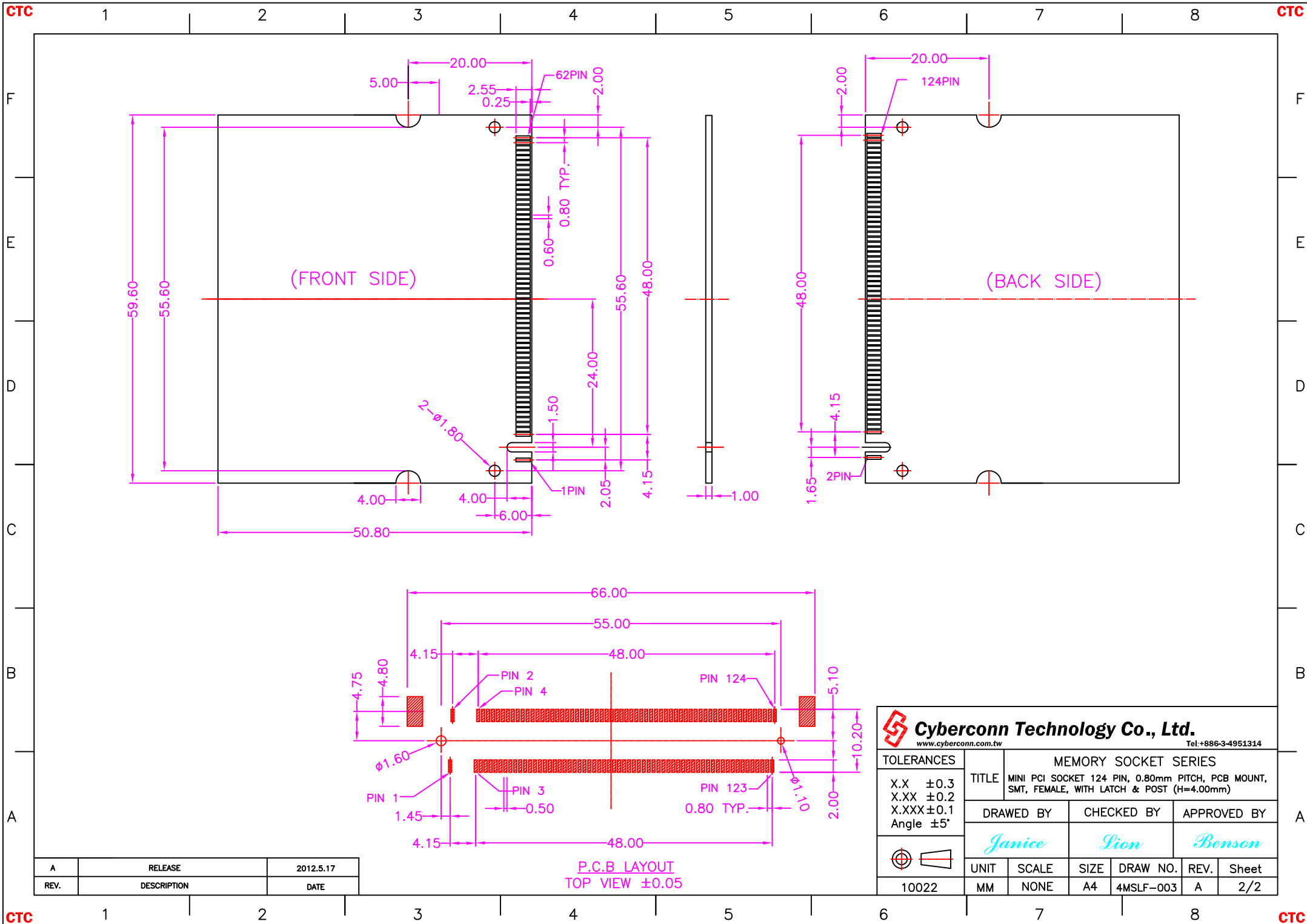
4MSLF - 1 2 4 * T - 1 1 3

SERIES ———— TRAY PACKAGE
 NO. OF POS. ———— TIN PLATING ON SOLDER TAIL
 CONTACT PLATED OPTION ————

1: GOLD FLASH
 2: 2u" GOLD
 3: 3u" GOLD
 5: 5u" GOLD
 6: 10u" GOLD
 7: 15u" GOLD
 9: 30u" GOLD

<p>Cyberconn Technology Co., Ltd. www.cyberconn.com.tw Tel: +886-3-4951314</p>		MEMORY SOCKET SERIES					
		TITLE MINI PCI SOCKET 124 PIN, 0.80mm PITCH, PCB MOUNT, SMT, FEMALE, WITH LATCH & POST (H=4.00mm)					
TOLERANCES		DRAWN BY		CHECKED BY		APPROVED BY	
X.X ±0.3 X.XX ±0.2 X.XXX ±0.1 Angle ±5°		<i>Janice</i>		<i>Lion</i>		<i>Benson</i>	
		UNIT	SCALE	SIZE	DRAW NO.	REV.	Sheet
10022		MM	NONE	A4	4MSLF-003	A	1/2

A	RELEASE	2012.5.17
REV.	DESCRIPTION	DATE



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TOLERANCES		DRAWN BY			CHECKED BY		APPROVED BY	
X.X	±0.3	<i>Janice</i>		<i>Lion</i>		<i>Benson</i>		
X.XX	±0.2	UNIT	SCALE	SIZE	DRAW NO.	REV.	Sheet	
X.XXX	±0.1	10022	NONE	A4	4MSLF-003	A	2/2	
Angle	±5°							